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200MHz to 6000MHz Quadrature Modulator with Ultrahigh OIP3

FEATURES

- Frequency Range: 200MHz to 6000MHz
- Output IP3: +31dBm Typical at 2140MHz (Uncalibrated)
 +35dBm Typical (User Optimized)
- Single Pin Calibration to Optimize OIP3
- Low Output Noise Floor at 6MHz Offset:

No RF: -160.6dBm/Hz

 $P_{OUT} = 5dBm: -155.5dBm/Hz$

- Integrated LO Buffer and LO Quadrature Phase Generator
- High Impedance DC Interface to Baseband Inputs with 0.5V Common Mode Voltage*
- 50Ω Single-Ended LO and RF Ports
- 3.3V Operation
- Fast Turn-Off/On: 10ns/17ns
- Temperature Sensor (Thermistor)
- 24-Lead UTQFN 4mm × 4mm Package

APPLICATIONS

- LTE, GSM/EDGE, W-CDMA, TD-SCDMA, CDMA2K, WiMax Basestations
- Image Reject Upconverters
- Point-to-Point Microwave Links
- Broadcast Modulator
- Military Radio

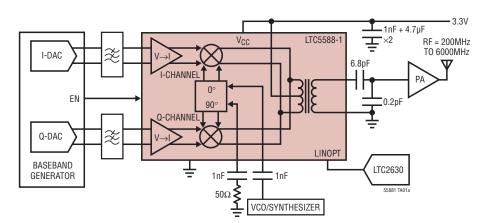
DESCRIPTION

The LTC®5588-1 is a direct conversion I/Q modulator designed for high performance wireless applications. It allows direct modulation of an RF signal using differential baseband I and Q signals. It supports LTE, GSM, EDGE, TD-SCDMA, CDMA, CDMA2000, W-CDMA, WiMax and other communication standards. It can also be configured as an image reject upconverting mixer, by applying 90° phase-shifted signals to the I and Q inputs. The I/Q baseband inputs drive double-balanced mixers. An onchip balun converts the differential mixer signals to a 50Ω single-ended RF output. Four balanced I and Q baseband input ports are DC-coupled with a common mode voltage level of 0.5V. The LO path consists of an LO buffer with single-ended or differential inputs and precision quadrature generators to drive the mixers. The supply voltage range is 3.15V to 3.45V. An external voltage can be applied to the LINOPT pin to further improve 3rd-order linearity performance. Accurate temperature dependent calibrations can be performed using the on-chip thermistor.

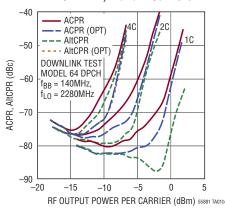
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TYPICAL APPLICATION

200MHz to 6000MHz Direct Conversion Transmitter Application



ACPR, AltCPR and ACPR, AltCPR with Optimized LINOPT Voltage vs RF Output Power at 2.14GHz for W-CDMA 1, 2 and 4 Carriers



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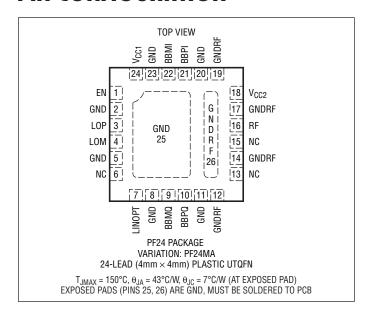
^{*}Contact LTC Marketing for other common mode voltage versions.

ABSOLUTE MAXIMUM RATINGS

(Note 1)

Supply Voltage	3.8V
Common Mode Level of BBPI, BBMI	
and BBPQ, BBMQ	0.55V
Voltage on Any Pin	$-0.3V$ to $V_{CC} + 0.3V$
T _{JMAX}	150°C
Operating Temperature Range	40°C to 85°C
Storage Temperature Range	65°C to 150°C

PIN CONFIGURATION



ORDER INFORMATION

LEAD FREE FINISH	TAPE AND REEL	PART MARKING	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LTC5588IPF-1#PBF	LTC5588IPF-1#TRPBF	5881T	24-Lead (4mm × 4mm) Plastic UTQFN	-40°C to 85°C

Consult LTC Marketing for parts specified with wider operating temperature ranges. Consult LTC Marketing for information on non-standard lead based finish parts.

For more information on lead free part marking, go to: http://www.linear.com/leadfree/

For more information on tape and reel specifications, go to: http://www.linear.com/tapeandreel/

ELECTRICAL CHARACTERISTICS $V_{CC} = 3.3V$, EN = 3.3V, $T_A = 25^{\circ}C$, LOP AC-terminated with 50Ω to ground, BBPI, BBMI, BBPQ, BBMQ common mode DC voltage $V_{CMBB} = 0.5V_{DC}$, I and Q baseband input signal = 100kHz CW, $1V_{P-P(DIFF)}$ each, I and Q 90° shifted, lower sideband selection, LINOPT pin floating, unless otherwise noted. Test circuit is shown in Figure 8.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
f_{LO} = 240MHz, f_{RF} = 239.9MHz, P_{LO} = 10dBm, P_{LO} = 4.7nH, P_{LO} = 33pF, Using U2 = Anaren P/N B0310J50100A00 Balun						
f _{RF(MATCH)}	RF Match Frequency Range	S22 < -10dB (Note 10)		200 to 244		MHz
f _{LO(MATCH)}	LO Match Frequency Range	S11 < -10dB	2	200 to 1500		MHz
G_V	Conversion Voltage Gain	20 • Log (V _{RF(OUT)(50Ω)} /V _{IN(DIFF)(I or Q)})		-5.9		dB
P _{OUT}	Absolute Output Power	1V _{P-P(DIFF)} CW Signal, I and Q		-1.9		dBm
OP1dB	Output 1dB Compression			5.1		dBm
OIP2	Output 2nd-Order Intercept	(Notes 4, 5)		77.3		dBm
OIP3	Output 3rd-Order Intercept	(Notes 4, 6)		28		dBm
NFloor	RF Output Noise Floor	No Baseband AC Input Signal (Note 3)		-168.3		dBm/Hz
IR	Image Rejection	(Note 7)		-27		dBc
LOFT	Carrier Leakage (LO Feedthrough)	(Note 7)		-53		dBm



ELECTRICAL CHARACTERISTICS $V_{CC} = 3.3V$, EN = 3.3V, $T_A = 25^{\circ}C$, LOP AC-terminated with 50Ω to ground, BBPI, BBMI, BBPQ, BBMQ common mode DC voltage $V_{CMBB} = 0.5V_{DC}$, I and Q baseband input signal = 100kHz CW, $1V_{P-P(DIFF)}$ each, I and Q 90° shifted, lower sideband selection, LINOPT pin floating, unless otherwise noted. Test circuit is shown in Figure 8.

SYMBOL	PARAMETER	CONDITIONS	MIN TYP MAX	UNITS
$f_{L0} = 450MH$	Hz, f _{RF} = 449.9MHz, P _{LO} = 10dBm, C	7 = 2.7nH, C8 = 10pF, U2 = Anaren P/N B0310J50	0100A00 Balun	
f _{RF(MATCH)}	RF Match Frequency Range	S22 < -10dB (Note 10)	350 to 468	MHz
f _{LO(MATCH)}	LO Match Frequency Range	S11 < -10dB	200 to 1500	MHz
G _V	Conversion Voltage Gain	20 • Log (V _{RF(OUT)(50Ω)} /V _{IN(DIFF)(I or Q)})	-2.6	dB
P _{OUT}	Absolute Output Power	1V _{P-P(DIFF)} CW Signal, I and Q	1.4	dBm
OP1dB	Output 1dB Compression		8.6	dBm
OIP2	Output 2nd-Order Intercept	(Notes 4, 5)	72	dBm
OIP3	Output 3rd-Order Intercept	(Notes 4, 6)	30	dBm
NFloor	RF Output Noise Floor	No Baseband AC Input Signal (Note 3) P _{OUT} = 1dBm (Note 3)	-165.2 -159.8	dBm/Hz dBm/Hz
IR	Image Rejection	(Note 7)	-53	dBc
LOFT	Carrier Leakage (LO Feedthrough)	(Note 7)	-45	dBm
f _{L0} = 900MH	Hz, f _{RF} = 899.9MHz, P _{LOM} = OdBm, (C7 = 6.8pF, C8 = 0.2pF		
f _{RF(MATCH)}	RF Match Frequency Range	S22 < -10dB	700 to 5000	MHz
f _{LO(MATCH)}	LO Match Frequency Range	S11 < -10dB	600 to 6000	MHz
G _V	Conversion Voltage Gain	20 • Log (V _{RF(OUT)(50Ω)} /V _{IN(DIFF)(I or Q)})	0	dB
P _{OUT}	Absolute Output Power	1V _{P-P(DIFF)} CW Signal, I and Q	4.0	dBm
OP1dB	Output 1dB Compression		12.1	dBm
OIP2	Output 2nd-Order Intercept	(Notes 4, 5)	73.6	dBm
OIP3	Output 3rd-Order Intercept	(Notes 4, 6) Optimized (Notes 4, 6, 11)	31.3 35.1	dBm dBm
NFloor	RF Output Noise Floor	No Baseband AC Input Signal (Note 3) P _{OUT} = 5dBm (Note 3) P _{LOM} = 10dBm	−161.6 −155.1	dBm/Hz dBm/Hz
IR	Image Rejection	(Note 7)	-45.5	dBc
LOFT	Carrier Leakage (LO Feedthrough)	(Note 7)	-43.1	dBm
		EN = Low (Note 7)	-68.9	dBm
	IHz, f _{RF} = 1899.9MHz, P _{LOM} = 0dBm			T
f _{RF(MATCH)}	RF Match Frequency Range	\$22 < -10dB	700 to 5000	MHz
†LO(MATCH)	LO Match Frequency Range	S11 < -10dB	600 to 6000	MHz
G _V	Conversion Voltage Gain	20 • Log (V _{RF(OUT)(50Ω)} /V _{IN(DIFF)(I or Q)})	0.4	dB
P _{OUT}	Absolute Output Power	1V _{P-P(DIFF)} CW Signal, I and Q	4.4	dBm
OP1dB	Output 1dB Compression		12.4	dBm
OIP2	Output 2nd-Order Intercept	(Notes 4, 5)	58.8	dBm
OIP3	Output 3rd-Order Intercept	(Notes 4, 6) Optimized (Notes 4, 6, 11)	30.3 32.7	dBm dBm
NFloor	RF Output Noise Floor	No Baseband AC Input Signal (Note 3)	-160.6	dBm/Hz
IR	Image Rejection	(Note 7)	-54.4	dBc
LOFT	Carrier Leakage (LO Feedthrough)	(Note 7)	-40.9	dBm



ELECTRICAL CHARACTERISTICS $V_{CC} = 3.3V$, EN = 3.3V, $T_A = 25^{\circ}C$, LOP AC-terminated with 50Ω to ground, BBPI, BBMI, BBPQ, BBMQ common mode DC voltage $V_{CMBB} = 0.5V_{DC}$, I and Q baseband input signal = 100kHz CW, $1V_{P-P(DIFF)}$ each, I and Q 90° shifted, lower sideband selection, LINOPT pin floating, unless otherwise noted. Test circuit is shown in Figure 8.

SYMBOL	PARAMETER	CONDITIONS	MIN TYP MAX	UNITS
	// IHz, f _{RF} = 2139.9MHz, P _{LOM} = 0dBn		MIN III MAX	ONITO
	RF Match Frequency Range	S22 < -10dB	700 to 5000	MHz
f _{RF(MATCH)}	LO Match Frequency Range	S11 < -10dB	600 to 6000	MHz
f _{LO(MATCH)} G _V	Conversion Voltage Gain	20 • Log (V _{RF(OUT)(50Ω)} /V _{IN(DIFF)(I or Ω)})	0.2	dB
P _{OUT}	Absolute Output Power	1V _{P-P(DIFF)} CW Signal, I and Q	4.2	dBm
OP1dB	Output 1dB Compression	1 VP-P(DIFF) OVV OIGHAI, I AND Q	12.0	dBm
OIP2	Output 2nd Order Intercept	(Notes 4, 5)	58.5	dBm
0IP3	Output 3rd Order Intercept	(Notes 4, 6)	30.9	dBm
OII 3	Output ord Order Intercept	Optimized (Notes 4, 6, 11)	35.1	dBm
NFloor	RF Output Noise Floor	No Baseband AC Input Signal (Note 3) P _{OUT} = 5dBm (Note 3) P _{LOM} = 10dBm	-160.6 -155.5	dBm/Hz dBm/Hz
IR	Image Rejection	(Note 7)	-56.6	dBc
LOFT	Carrier Leakage (LO Feedthrough)	(Note 7)	-39.6	dBm
f _{L0} = 2600N	NHz, f _{RF} = 2599.9MHz, P _{LOM} = OdBn	n, C7 = 6.8pF, C8 = 0.2pF		
f _{RF(MATCH)}	RF Match Frequency Range	S22 < -10dB	700 to 5000	MHz
f _{LO(MATCH)}	LO Match Frequency Range	S11 < -10dB	600 to 6000	MHz
G _V	Conversion Voltage Gain	20 • Log (V _{RF(OUT)(50Ω)} /V _{IN(DIFF)(I or Q)})	-0.2	dB
P _{OUT}	Absolute Output Power	1V _{P-P(DIFF)} CW Signal, I and Q	3.8	dBm
OP1dB	Output 1dB Compression		11.4	dBm
OIP2	Output 2nd-Order Intercept	(Notes 4, 5)	61.1	dBm
OIP3	Output 3rd-Order Intercept	(Notes 4, 6) Optimized (Notes 4, 6, 11)	29.2 39.5	dBm dBm
NFloor	RF Output Noise Floor	No Baseband AC Input Signal (Note 3)	-160.5	dBm/Hz
IR	Image Rejection	(Note 7)	-48.8	dBc
LOFT	Carrier Leakage (LO Feedthrough)	(Note 7)	-35.5	dBm
$f_{L0} = 3500N$	MHz, f _{RF} = 3499.9MHz, P _{LOM} = 0dBn	n, C7 = 6.8pF, C8 = 0.2pF		
f _{RF(MATCH)}	RF Match Frequency Range	S22 < -10dB	700 to 5000	MHz
f _{LO(MATCH)}	LO Match Frequency Range	S11 < -10dB	600 to 6000	MHz
G _V	Conversion Voltage Gain	20 • Log (V _{RF(OUT)(50Ω)} /V _{IN(DIFF)(I or Q)})	-1.0	dB
P _{OUT}	Absolute Output Power	1V _{P-P(DIFF)} CW Signal, I and Q	3.0	dBm
OP1dB	Output 1dB Compression		10.5	dBm
OIP2	Output 2nd-Order Intercept	(Notes 4, 5)	67.6	dBm
OIP3	Output 3rd-Order Intercept	(Notes 4, 6) Optimized (Notes 4, 6, 11)	23.5 27.5	dBm dBm
NFloor	RF Output Noise Floor	No Baseband AC Input Signal (Note 3)	-160.1	dBm/Hz
IR	Image Rejection	(Note 7)	-36.8	dBc
LOFT	Carrier Leakage (LO Feedthrough)	(Note 7)	-37.5	dBm
$f_{L0} = 5800 N$	MHz, $f_{RF} = 5799.9$ MHz, $P_{LOM} = 0$ dBn	n, C7 = 6.8pF, C8 = 0.2pF		
f _{RF(MATCH)}	RF Match Frequency Range	S22, < -10dB	700 to 5000	MHz
f _{LO(MATCH)}	LO Match Frequency Range	S11, < -10dB	600 to 6000	MHz
G _V	Conversion Voltage Gain	20 • Log (V _{RF(OUT)(50Ω)} /V _{IN(DIFF)(I or Q)})	-9.1	dB
P _{OUT}	Absolute Output Power	1V _{P-P(DIFF)} CW Signal, I and Q	-5.1	dBm

/ LINEAR

ELECTRICAL CHARACTERISTICS $V_{CC}=3.3V,~EN=3.3V,~T_A=25^{\circ}C,~LOP~AC$ -terminated with 50Ω to ground, BBPI, BBMI, BBPQ, BBMQ common mode DC voltage $V_{CMBB}=0.5V_{DC},~I~and~Q~baseband~input~signal=100kHz~CW,~1V_{P-P(DIFF)}~each,~I~and~Q~90^{\circ}~shifted,~lower~sideband~selection,~LINOPT~pin~floating,~unless~otherwise~noted.~Test~circuit~is~shown~in~Figure~8.$

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
OP1dB	Output 1dB Compression			1.9		dBm
OIP2	Output 2nd-Order Intercept	(Notes 4, 5)		35.4		dBm
OIP3	Output 3rd-Order Intercept	(Notes 4, 6)		17.9		dBm
NFloor	RF Output Noise Floor	No Baseband AC Input Signal (Note 3)		-156.7		dBm/Hz
IR	Image Rejection	(Note 7)		-32.3		dBc
LOFT	Carrier Leakage (LO Feedthrough)	(Note 7)		-30.2		dBm
Baseband Ir	iputs (BBPI, BBMI, BBPQ, BBMQ)					
BW _{BB}	Baseband Bandwidth	-1 dB Bandwidth, R _{SOURCE} = 25 Ω , Single Ended		430		MHz
I _{b(BB)}	Baseband Input Current	Single Ended		-136		μA
R _{IN(SE)}	Input Resistance	Single Ended		-3		kΩ
V _{CMBB}	DC Common Mode Voltage	Externally Applied		0.5		V
V _{SWING}	Amplitude Swing	No Hard Clipping, Single Ended		0.86		V _{P-P}
Power Supp	ly (V _{CC1} , V _{CC2})					
V _{CC}	Supply Voltage		3.15	3.3	3.45	V
I _{CC(ON)}	Supply Current	EN = High	275	303	325	mA
I _{CC(OFF)}	Supply Current, Sleep Mode	EN = 0V		33	900	μА
t _{ON}	Turn-On Time	EN = Low to High (Notes 8, 13)		17		ns
t _{OFF}	Turn-Off Time	EN = High to Low (Notes 9, 13)		10		ns
t _{ON(IR)}	Image Rejection Settling	EN = Low to High, <-60dBc (Note 13)		80		ns
t _{ON(LO)}	LO Suppression Settling	EN = Low to High, <-60dBm (Note 13)		85		ns
t _{ON(PHASE)}	Phase Settling	EN = Low to High, Phase < 0.5°, f _{LOM} = f _{RF} = 2.14GHz, Constant Board Temperature		70		ns
V _{LINOPT(ON)}	LINOPT Voltage	Floating LINOPT Pin, EN = High		2.56		V
V _{LINOPT(OFF)}	LINOPT Voltage, Sleep Mode	Floating LINOPT Pin, EN = Low		3.3		V
Enable Pin						
Enable	Input High Voltage Input High Current	EN = High EN = 3.3V	2	80		V nA
Sleep	Input Low Voltage Input Low Current	EN = Low EN = OV		33	1	V µA
Temperatur	Sensor (Thermistor) (Note 14)					
R_{T}	Thermistor Resistance	EN = Low, I _{RT} = 100μA		1.385		kΩ
	Temperature Slope	EN = Low, I _{RT} = 100μA		11		Ω/°C

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

Note 2: The LTC5588-1 is guaranteed functional over the operating temperature range from -40°C to 85°C.

Note 3: At 6MHz offset from the LO signal frequency. 100nF between BBPI and BBMI, 100nF between BBPQ and BBMQ.

Note 4: Baseband inputs are driven with 4.5MHz and 5.5MHz tones.

Note 5: IM2 is measured at $f_{1,0} - 10MHz$.

Note 6: IM3 is measured at $f_{LO} - 3.5$ MHz and $f_{LO} - 6.5$ MHz. OIP3 = lowest of (1.5 • P{ f_{LO} -5.5MHz} - 0.5 • P{ f_{LO} -6.5MHz}) and (1.5 • P{ f_{LO} -4.5MHz} - 0.5 • P{ f_{LO} -3.5MHz}).

Note 7: Without image or LO feedthrough nulling (unadjusted).

Note 8: RF power is within 10% of final value.

Note 9: RF power is at least 30dB down from its ON state.

Note 10: RF matching center frequency is set below band center frequency in order to align RF passband center frequency with band center frequency.

Note 11: An external voltage is optimally set at the LINOPT pin for best output 3rd-order intercept.

Note 12: I and Q baseband Input signal = 10MHz CW, $0.8V_{P-P,\,DIFF}$ each, I and Q 0° shifted.

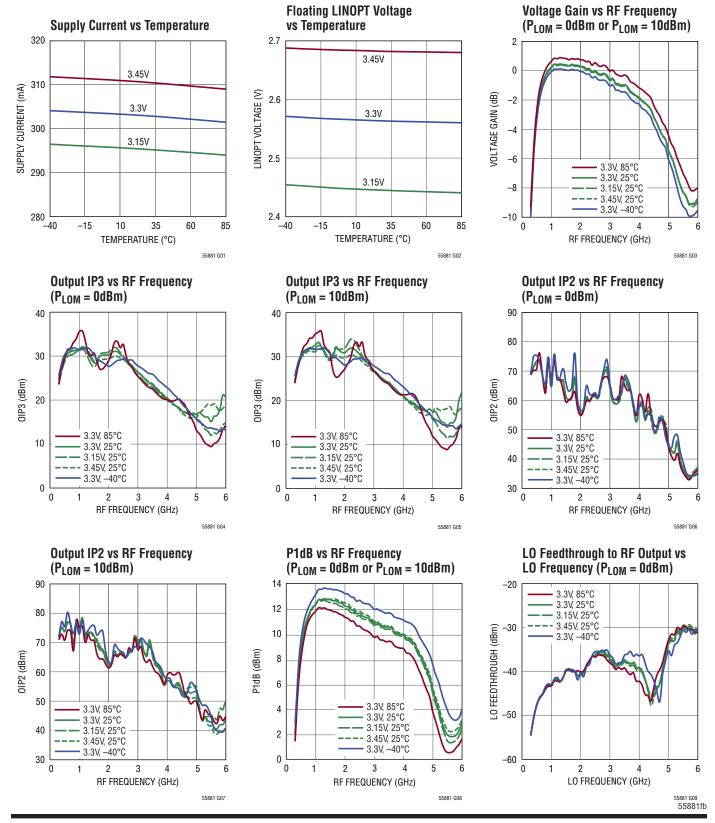
Note 13: $f_{LOM}=2.14GHz$, $P_{LOM}=0dBm$, $f_{BB}=134MHz$; LO feedthrough and image rejection is nulled during previous EN = high cycles, C5 = C6 = 10pF; C13 = 0; Extra $680\mu F$ capacitors (SANYO 6SEPC680M) from TP1 to ground and TP2 to ground, RF noise filter with 93MHz bandwidth is used.

Note 14: Thermistor performance is guaranteed by Design.

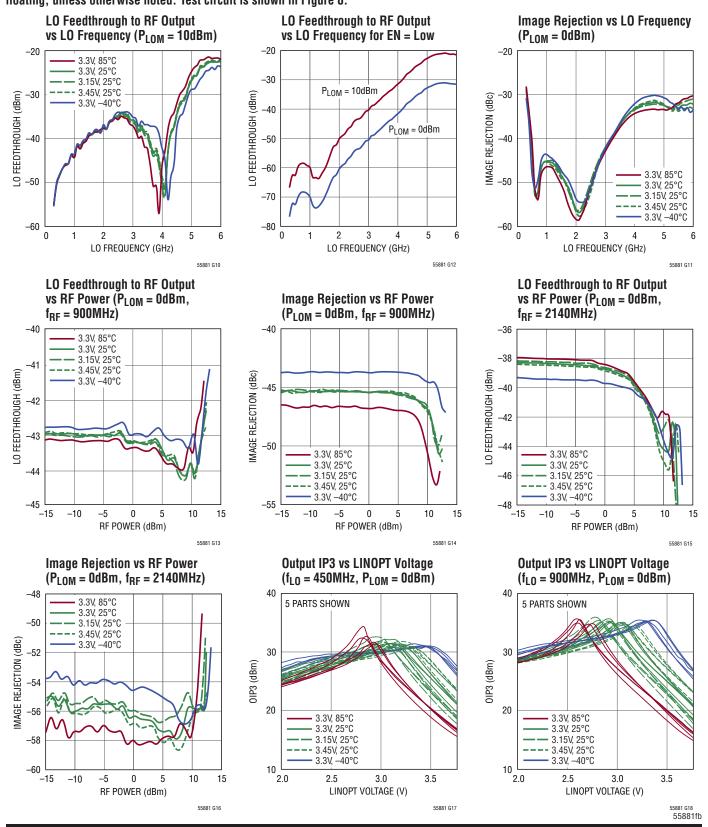
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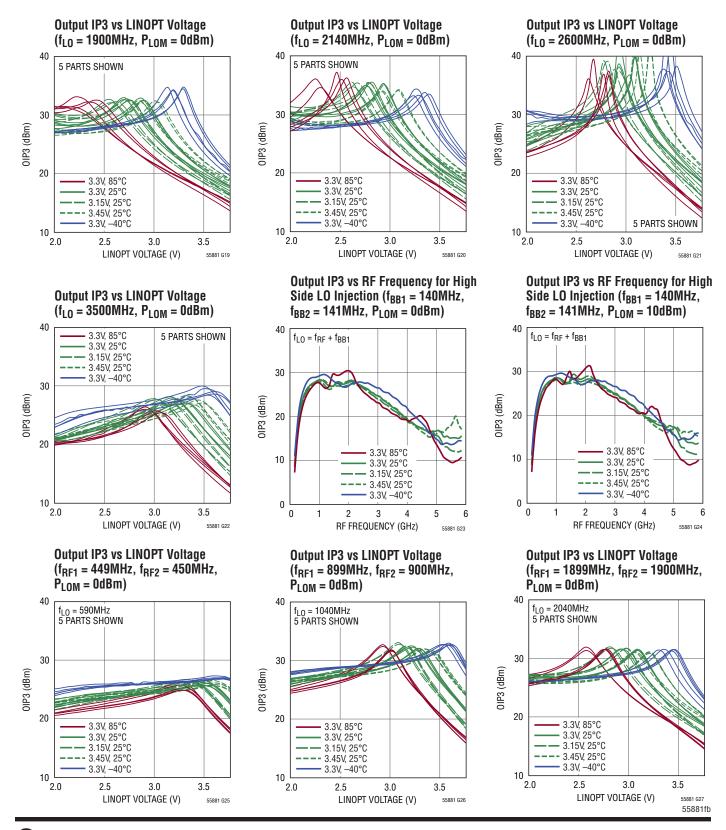
TYPICAL PERFORMANCE CHARACTERISTICS $V_{CC} = 3.3V$, EN = 3.3V, $T_A = 25^{\circ}C$, LOP input AC-terminated with 50Ω to ground, BBPI, BBMI, BBPQ, BBMQ inputs $0.5V_{DC}$, and $1V_{P-P(DIFF)}$, baseband input frequencies = 4.5MHz and 5.5MHz for OIP3 and OIP2, or else baseband input frequency = 100kHz, I and Q 90° shifted, lower sideband selection, LINOPT pin floating, unless otherwise noted. Test circuit is shown in Figure 8.



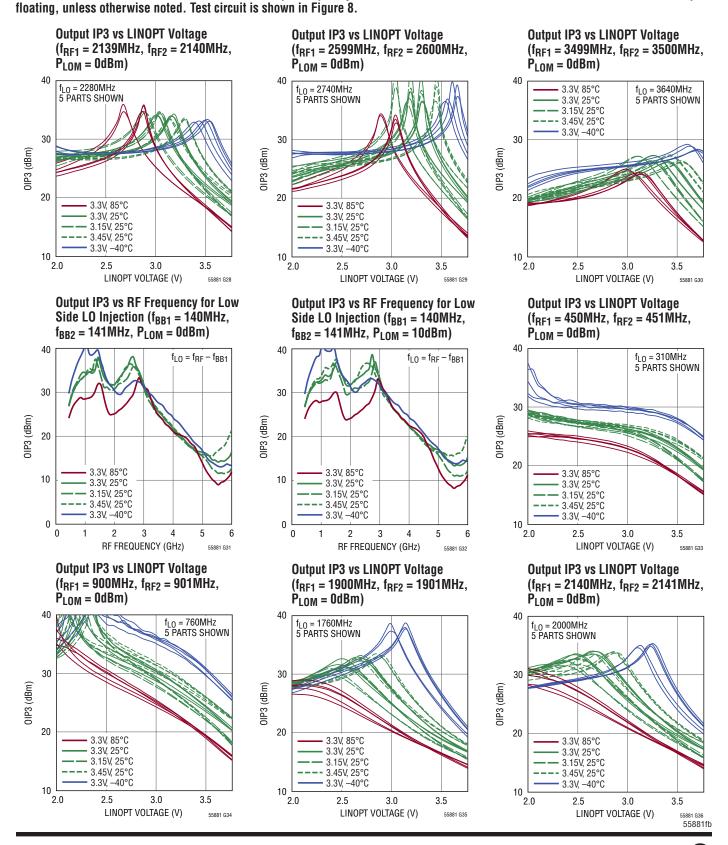
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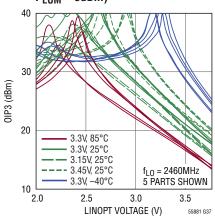
TYPICAL PERFORMANCE CHARACTERISTICS $V_{CC} = 3.3V$, EN = 3.3V, $T_A = 25^{\circ}C$, LOP input AC-terminated with 50Ω to ground, BBPI, BBMI, BBPQ, BBMQ inputs $0.5V_{DC}$, and $1V_{P-P(DIFF)}$, baseband input frequencies = 4.5MHz and 5.5MHz for OIP3 and OIP2, or else baseband input frequency = 100kHz, I and Q 90° shifted, lower sideband selection, LINOPT pin floating, upless otherwise noted. Took election in Figure 9.



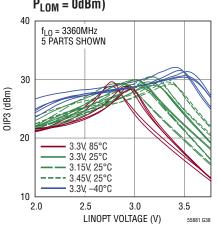
TYPICAL PERFORMANCE CHARACTERISTICS $V_{CC}=3.3V$, EN = 3.3V, $T_A=25^{\circ}C$, LOP input AC-terminated with 50Ω to ground, BBPI, BBMI, BBPQ, BBMQ inputs $0.5V_{DC}$, and $1V_{P-P(DIFF)}$, baseband input frequencies = 4.5MHz

and 5.5MHz for OIP3 and OIP2, or else baseband input frequency = 100kHz, I and Q 90° shifted, lower sideband selection, LINOPT pin floating, unless otherwise noted. Test circuit is shown in Figure 8.

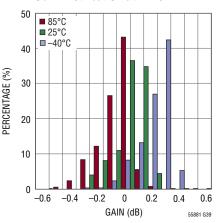
Output IP3 vs LINOPT Voltage $(f_{RF1} = 2600MHz, f_{RF2} = 2601MHz,$ $P_{LOM} = 0dBm$)



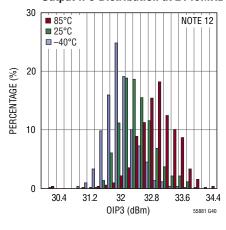
Output IP3 vs LINOPT Voltage $(f_{RF1} = 3500MHz, f_{RF2} = 3501MHz,$ $P_{LOM} = 0dBm$)



Gain Distribution at 2140MHz



Output IP3 Distribution at 2140MHz



LO Feedthrough Distribution at 2140MHz

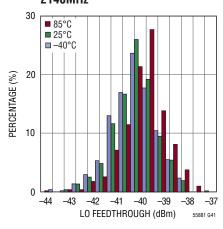
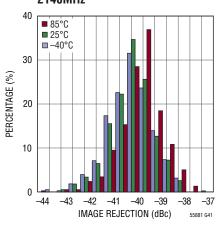
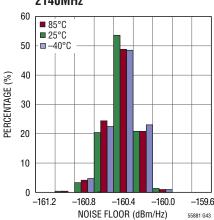


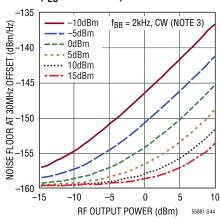
Image Rejection Distribution at 2140MHz



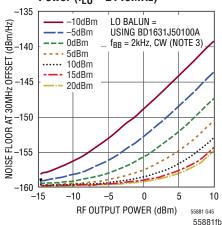
Output Noise Floor Distribution at 2140MHz



Output Noise Floor vs RF Output Power and LOM Port Input Power $(f_{LO} = 2140MHz)$

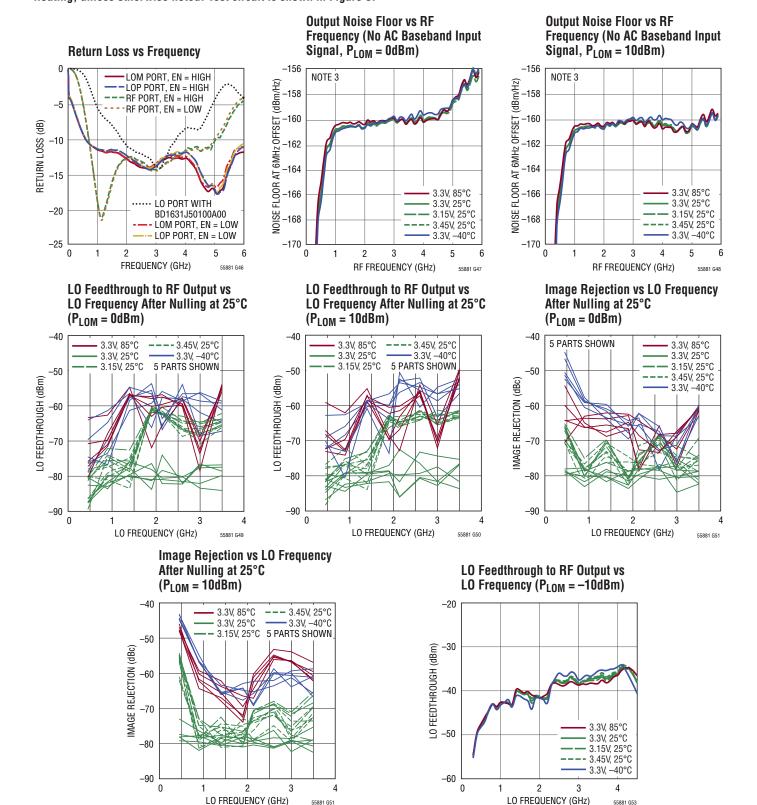


Output Noise Floor vs RF Output Power and Differential LO Input Power $(f_{L0} = 2140MHz)$



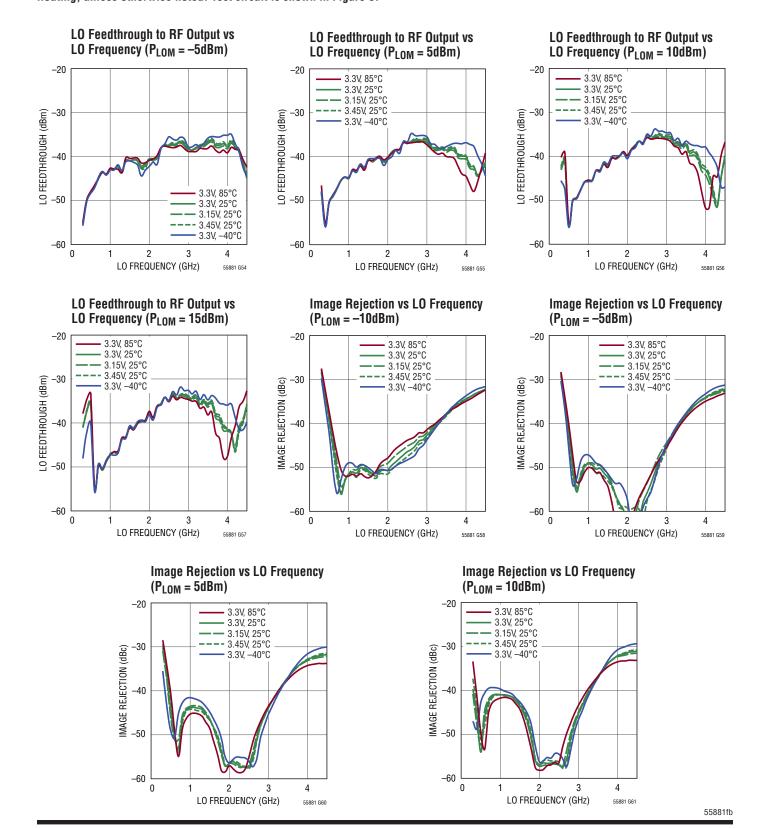


TYPICAL PERFORMANCE CHARACTERISTICS $V_{CC} = 3.3V$, EN = 3.3V, $T_A = 25^{\circ}C$, LOP input AC-terminated with 50Ω to ground, BBPI, BBMI, BBPQ, BBMQ inputs $0.5V_{DC}$, and $1V_{P-P(DIFF)}$, baseband input frequencies = 4.5MHz and 5.5MHz for OIP3 and OIP2, or else baseband input frequency = 100kHz, I and Q 90° shifted, lower sideband selection, LINOPT pin floating, unless otherwise noted. Test circuit is shown in Figure 8.



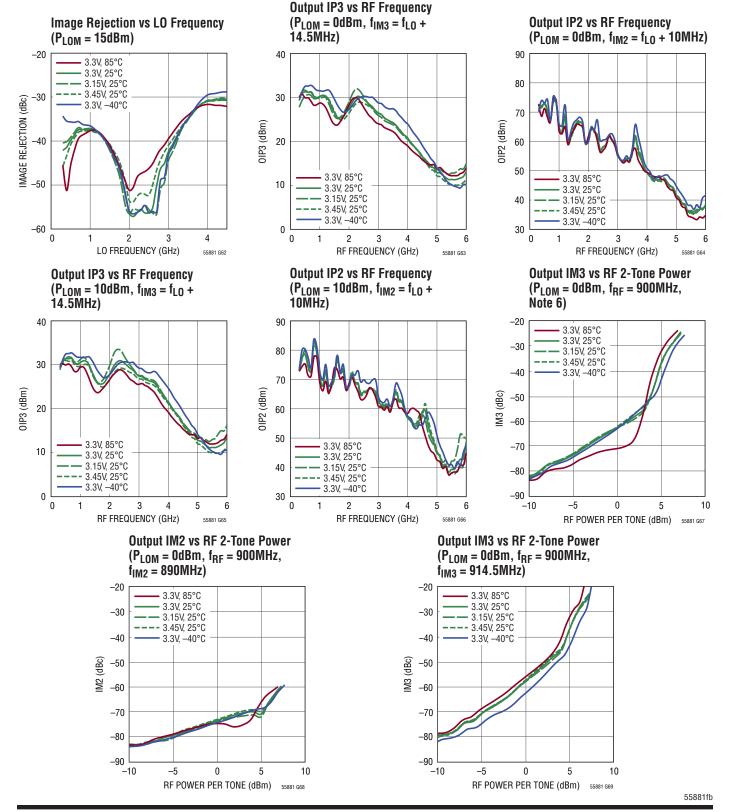
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TYPICAL PERFORMANCE CHARACTERISTICS $V_{CC} = 3.3V$, EN = 3.3V, $T_A = 25^{\circ}C$, LOP input AC-terminated with 50Ω to ground, BBPI, BBMI, BBPQ, BBMQ inputs $0.5V_{DC}$, and $1V_{P-P(DIFF)}$, baseband input frequencies = 4.5MHz and 5.5MHz for OIP3 and OIP2, or else baseband input frequency = 100kHz, I and Q 90° shifted, lower sideband selection, LINOPT pin floating, unless otherwise noted. Test circuit is shown in Figure 8.

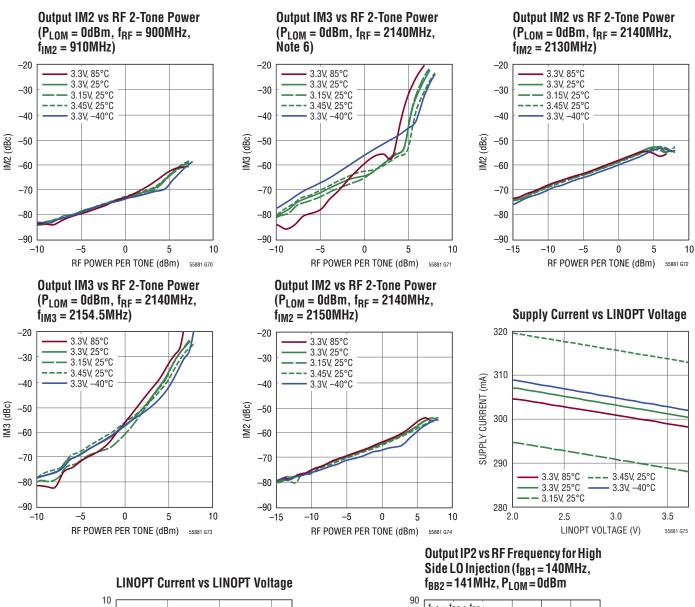




TYPICAL PERFORMANCE CHARACTERISTICS $V_{CC} = 3.3V$, EN = 3.3V, $T_A = 25^{\circ}C$, LOP input AC-terminated with 50Ω to ground, BBPI, BBMI, BBPQ, BBMQ inputs $0.5V_{DC}$, and $1V_{P-P(DIFF)}$, baseband input frequencies = 4.5MHz and 5.5MHz for OIP3 and OIP2, or else baseband input frequency = 100kHz, I and Q 90° shifted, lower sideband selection, LINOPT pin floating, unless otherwise noted. Test circuit is shown in Figure 8.



TYPICAL PERFORMANCE CHARACTERISTICS $V_{CC} = 3.3V$, EN = 3.3V, $T_A = 25^{\circ}C$, LOP input AC-terminated with 50Ω to ground, BBPI, BBMI, BBPQ, BBMQ inputs $0.5V_{DC}$, and $1V_{P-P(DIFF)}$, baseband input frequencies = 4.5MHz and 5.5MHz for OIP3 and OIP2, or else baseband input frequency = 100kHz, I and Q 90° shifted, lower sideband selection, LINOPT pin floating, unless otherwise noted. Test circuit is shown in Figure 8.





-5 └ 2.0 3.45V. 25°C

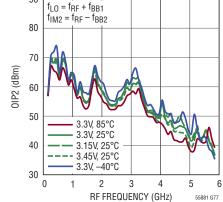
3 3V -40°C

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LINOPT VOLTAGE (V)

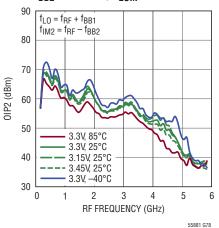


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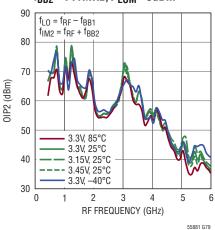
LINEAD TECHNOLOGY

TYPICAL PERFORMANCE CHARACTERISTICS $V_{CC}=3.3V$, EN = 3.3V, $T_A=25^{\circ}C$, LOP input AC-terminated with 50Ω to ground, BBPI, BBMI, BBPQ, BBMQ inputs $0.5V_{DC}$, and $1V_{P-P(DIFF)}$, baseband input frequencies = 4.5MHz and 5.5MHz for OIP3 and OIP2, or else baseband input frequency = 100kHz, I and Q 90° shifted, lower sideband selection, LINOPT pin floating, unless otherwise noted. Test circuit is shown in Figure 8.

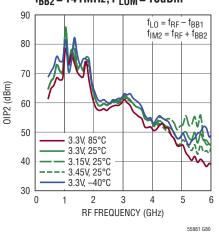
Output IP2 vs RF Frequency for High Side LO Injection ($f_{BB1} = 140MHz$, $f_{BB2} = 141MHz, P_{LOM} = 10dBm$



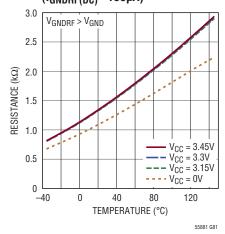
Output IP2 vs RF Frequency for Low Side LO Injection ($f_{BB1} = 140MHz$, $f_{BB2} = 141MHz, P_{LOM} = 0dBm$



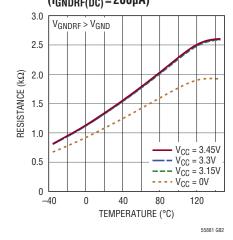
Output IP2 vs RF Frequency for Low Side LO Injection ($f_{BB1} = 140 MHz$, $f_{BB2} = 141MHz, P_{LOM} = 10dBm$



GNDRF to GND Thermistor DC Resistance vs Temperature $(I_{GNDRF(DC)} = 100 \mu A)$



GNDRF to GND Thermistor DC Resistance vs Temperature $(I_{GNDRF(DC)} = 200 \mu \dot{A})$



PIN FUNCTIONS

EN (Pin 1): Enable Input. When the enable pin voltage is higher than 2V, the IC is on. When the input voltage is less than 1V, the IC is off.

GND (Pins 2, 5, 8, 11, 12, 14, 17, 19, 20, 23, Exposed Pad Pins 25 and 26): Ground. Pins 2, 5, 8, 11, 20, 23 and exposed pad Pin 25 (group 1) are connected together internally while Pins 12, 14, 17, 19 and exposed pad Pin 26 (group 2) are tied together and serve as the ground return for the RF balun. For best overall performance all ground pins should be connected to RF ground. For best OIP2 performance it is recommended to connect group 1 and group 2 only at second and lower level ground layers of the PCB, not the top layer. A thermistor (temperature variable resistor) of $1.4k\Omega$ at 25° C and $V_{CC} = 3.3V$ with temperature coefficient of $11\Omega/^{\circ}$ C is connected between group 1 and group 2.

LOP (Pin 3): Positive LO Input. An AC-coupling capacitor (1nF) in series with 50Ω to ground provides the best OIP2 performance.

LOM (Pin 4): Negative LO Input. An AC-coupled 50Ω LO signal source can be applied to this pin.

NC (Pins 6, 13, 15): No Electrical Connection.

LINOPT (Pin 7): Linearity Optimization Input. An external voltage can be applied to this pin to optimize the linearity (OIP3) under a specific application condition. Its optimum voltage depends on the LO frequency, temperature, supply voltage, baseband frequency and signal bandwidth. The typical input voltage range is from 2V to 3.7V. The pin can be left floating for good overall linearity performance.

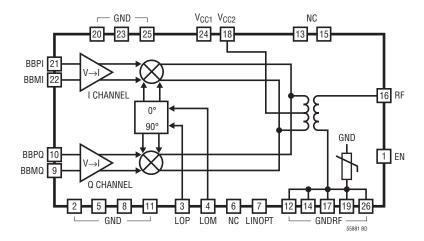
BBMQ, **BBPQ** (**Pins 9**, **10**): Baseband Inputs of the Q Channel. The input impedance of each input is about $-3k\Omega$. It should be externally biased to a 0.5V common mode level. Do not apply common mode voltage beyond 0.55V_{DC}.

RF (Pin 16): RF Output. The RF output is a DC-coupled single-ended output with 50Ω output impedance at RF frequencies. An AC-coupling capacitor of 6.2pF (C7), should be used at this pin for 0.7GHz to 3.5GHz operation.

 V_{CC1} , V_{CC2} (Pins 24, 18): Power Supply. It is recommended to use 2×1 nF and $2 \times 4.7 \mu$ F capacitors for decoupling to ground on these pins.

BBPI, BBMI (Pins 21, 22): Baseband Inputs of the I Channel. The input impedance of each input is about $-3k\Omega$. It should be externally biased to a 0.5V common mode level. Do not apply common mode voltage beyond $0.55V_{DC}$.

BLOCK DIAGRAM



LINEAR TECHNOLOGY

The LTC5588-1 consists of I and Q input differential voltage-to-current converters, I and Q upconverting mixers, an RF output balun, an LO quadrature phase generator and LO buffers.

External I and Q baseband signals are applied to the differential baseband input pins, BBPI, BBMI and BBPQ, BBMQ. These voltage signals are converted to currents and translated to RF frequency by means of double-balanced upconverting mixers. The mixer outputs are combined at the inputs of the RF output balun, which also transforms the output impedance to 50Ω . The center frequency of the resulting RF signal is equal to the LO signal frequency. The LO input drives a phase shifter which splits the LO signal into in-phase and quadrature signals. These LO signals are then applied to on-chip buffers which drive the upconverting mixers. In most applications, the LOM input is driven by the LO source via a 1nF coupling capacitor. while the LOP input is terminated with 50Ω to RF ground via a 1nF coupling capacitor. The RF output is single ended and internally 50Ω matched across a wide RF frequency range from 700MHz to 5GHz with better than 10dB return loss using C7 = 6.8pF and C8 = 0.2pF (S22 < -10dB). See Figure 8.

For 240MHz operation, C7 = 4.7nH and C8 = 33pF is recommended. For 450MHz, C7 = 2.7nH and C8 = 10pF is

recommended. Note that the frequency of the best match is set lower than the band center frequency to compensate the gain roll-off of the on-chip RF output balun at lower frequency. At 240MHz and 450MHz operations, the image rejection and the large-signal noise performance is better using higher LO drive levels. However, if the drive level causes internal clipping, the LO leakage degrades. Using a balun such as Anaren P/N B0310J50100A00 increases the LO drive level without internal clipping and provides a relatively broadband LO port impedance match.

Baseband Interface

The baseband inputs (BBPI, BBMI, BBPQ, BBMQ) present a single-ended input impedance of about $-3k\Omega$. Because of the negative input impedance, it is important to keep the source resistance at each baseband input low enough such that the total input impedance remains positive across the baseband frequency. Each of the four baseband inputs has a capacitor of 4pF in series with 14Ω connected to ground and a PNP emitter follower in parallel (see Figure 1). The baseband bandwidth depends on the source impedance. For a 25Ω source impedance (50Ω terminated with 50Ω), the baseband bandwidth (-1dB) is about 430MHz. If a 2.7nH series inductor is inserted at each of the four baseband inputs, the -1dB baseband bandwidth can be increased to about 650MHz.

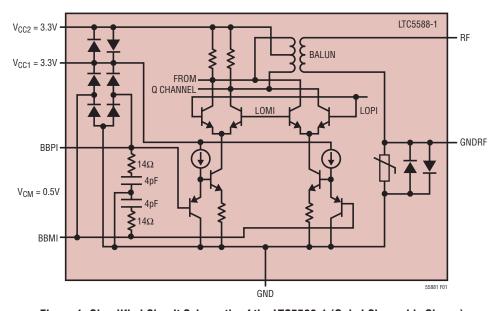


Figure 1. Simplified Circuit Schematic of the LTC5588-1 (Only I Channel is Shown)



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It is recommended to compensate the baseband input impedance in the baseband lowpass filter design in order to achieve best gain flatness vs baseband frequency. The S-parameters for (each of) the baseband inputs is given in Table 1.

Table 1. Single-Ended BB Input Impedance vs Frequency for EN = High and V_{DC} = 0.5V

FREQUENCY	BB INPUT	REFLECTION	COEFFICIENT
(MHz)	IMPEDANCE	MAG	ANGLE
0.1	-3700	1.03	-0.13
1	-3900-j340	1.03	-0.13
2	-3700-j950	1.03	-0.37
4	-3200-j1500	1.03	-0.68
8	-2100-j1900	1.03	-1.38
16	-860-j1600	1.03	-2.79
30	-300-j990	1.03	-5.3
60	-87-j520	1.03	-10.6
100	-35-j308	1.04	-18.2
140	-16-j226	1.03	-24.8
200	-6-j154	1.02	-36
250	-1.4-j120	1.01	-45
300	1.4-j102	0.99	-52
350	4.4-j87	0.96	-59
400	5.4-j74	0.94	-67
450	7-j66	0.90	-73
500	8.3-j58	0.87	-80
600	9.4-j47	0.82	-92
700	10-j38	0.77	-102
800	10-j32	0.74	-113
900	10.5-j27	0.71	-122
1000	10.5-j23	0.69	-129

The circuit is optimized for a common mode voltage of 0.5V which should be externally applied. The baseband pins should not be left floating to cause the internal PNP's base current to pull the common mode voltage higher than the 0.55V limit, generating excessive current flow. If it occurs for an extended period, damage to the IC may result. In shutdown mode it is recommended to terminate to ground or to a 0.5V source with a value lower than 200Ω . The PNP's base current is about $-136\mu\text{A}$ ranging from $-250\mu\text{A}$ to $-50\mu\text{A}$.

It is recommended to drive the baseband inputs differentially to reduce even-order distortion products. When a DAC is used as the signal source, a reconstruction filter should be placed between the DAC output and the LTC5588-1 baseband inputs to avoid aliasing.

Figure 2 shows a typical baseband interface for zero-IF repeater application. A 5th-order lowpass ladder filter is used with -0.3dB cut-off of 60MHz. C1A, C1B, C3A and C3B are configured in a single-ended fashion in order to suppress common mode noise. L3A and L3B (0402 size) are used to compensate for passband droop due to the finite quality factor of the inductors L1A, L1B, L2A and L2B (0603 size). R3A and R3B improves the out-of-band noise performance. R3A = R3B = 0Ω (L3A and L3B omitted) provides best out-of-band noise performance but no passband droop compensation. In that case, L1A, L1B, L2A and L2B may have to be increased in size (higher quality factor) to limit passband droop.

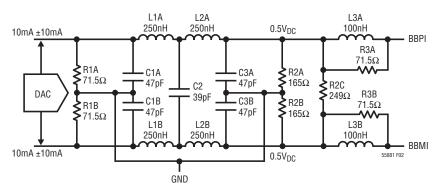


Figure 2: Baseband Interface with 5th-Order Filter and 0.5V_{CM} DAC (Only I Channel is Shown)

LINEAR TECHNOLOGY

At each baseband pin, a 0.146V to 0.854V swing is developed corresponding to a DAC output current of 0mA to 20mA. A 3dB lower gain can be achieved using R1A = R1B = 49.9 Ω ; R2A = R2B = 0pen; R2C = 100 Ω ; R3A = R3B = 51 Ω ; L1A = L1B = L2A = L2B = 180nH; C1A = C1B = C3A = C3B = 68pF; C2 = 56pF.

LO Section

The internal LO chain consists of a quadrature phase shifter followed by LO buffers. The LOM input can be driven single ended with 50Ω input impedance, while the LOP input should be terminated with 50Ω through a DC blocking capacitor.

The LOP and LOM inputs can also be driven differentially when an exceptionally low large-signal output noise floor is required.

A simplified circuit schematic for the LOP and LOM inputs is given in Figure 3. Table 2 lists LOM port input impedance vs frequency at EN = High and P_{LOM} = 0dBm. For EN = Low and P_{LOM} = 0dBm the input impedance is given in Table 3. The LOM port input impedance is shown for EN = High and Low at P_{LOM} = 10dBm in Table 4 and Table 5, respectively. The circuit schematic of the demo board is shown in Figure 8. A 50Ω termination can be connected to the LOP port (J1).

The LOM port (J2) can also be terminated with a 50Ω while the LO power is applied to the LOP (J1) port. In that case, the image rejection may be degraded. At 2.14GHz, the large-signal noise figure is about 2dB better for dif-

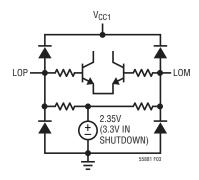


Figure 3: Simplified Circuit Schematic for the LOP and LOM inputs

ferential LO drive (using BD1631J50100A00) with a LO power below 10dBm. The balun (U2) can be installed by removing C5 and C6 (see Figure 8). Using Anaren P/N B0310J50100A00 improves image, LO leakage and large-signal noise performance at 240MHz and 450MHz. For this particular balun, an external blocking capacitor is required.

Figure 4 shows the return loss vs RF frequency for the 240MHz and 450MHz frequency bands. Figure 5 shows the corresponding gain vs RF frequency where the gain curve peaks at a higher frequency compared to the frequency with best match. Note that the overall bandwidth degrades tuning the matching frequency lower. A similar technique can be used for 700MHz and 900MHz if gain flatness is important.

Table 2. LOM Port Input Impedance vs Frequency for EN = High and P_{LOM} = 0dBm (LOP Terminated with 50 Ω AC to Ground)

FREQUENCY	LOM INPUT	REFLECTION COEFFICIEN	
(GHz)	IMPEDANCE	MAG	ANGLE
0.2	98-j65	0.499	-29.8
0.25	87-j58	0.462	-34.3
0.3	79-j51	0.421	-38.8
0.4	69-j40	0.354	-45.8
0.5	63-j32	0.296	-52.4
0.6	59-j27	0.256	-58.4
0.7	55-j24	0.225	-64.9
0.8	52-j21	0.203	-72.5
0.9	50-j19	0.188	-79.6
1.0	48-j18	0.18	-86.9
1.2	44-j16	0.178	-101
1.4	41-j15	0.185	-111
1.6	39-j14	0.194	-118
1.8	38-j13	0.2	-123
2.0	37-j12	0.199	-128
2.5	36-j7.8	0.189	-146
3.0	32-j2.4	0.225	-171
3.5	28+j1.0	0.288	176
4.0	25+j2.4	0.35	173
4.5	23+j4.1	0.372	168
5.0	21+j6.2	0.417	162
5.5	19+j7.9	0.472	159
6.0	17+j8.7	0.519	157



Table 3. LOM Port Input Impedance vs Frequency for EN = Low and P_{LOM} = 0dBm (LOP Terminated with 50 $\!\Omega$ AC to Ground)

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FREQUENCY	LOM INPUT	REFLECTION	COEFFICIENT	
(GHz)	IMPEDANCE	MAG	ANGLE	
0.2	95-j69	0.511	-31.4	
0.25	84-j61	0.472	-36.2	
0.3	76-j53	0.43	-41	
0.4	67-j41	0.36	-48.5	
0.5	61-j33	0.3	-55.6	
0.6	57-j28	0.259	-61.9	
0.7	54-j24	0.228	-68.7	
0.8	51-j21	0.205	-76.5	
0.9	48-j19	0.191	-83.6	
1.0	47-j18	0.183	-90.9	
1.2	43-j16	0.182	-105	
1.4	40-j15	0.19	-114	
1.6	39-j14	0.2	-121	
1.8	38-j13	0.207	-125	
2.0	37-j12	0.205	-131	
2.5	35-j7.6	0.2	-149	
3.0	31-j2.2	0.238	-172	
3.5	27+j1.3	0.303	175	
4.0	24+j2.9	0.363	171	
4.5	22+j4.7	0.387	166	
5.0	21+j7.0	0.427	160	
5.5	18+j8.7	0.481	157	
6.0	16+j9.7	0.524	154	

Table 4. LOM Port Input Impedance vs Frequency for EN = High and P_{LOM} = 10dBm (LOP Terminated with 50Ω AC to Ground)

FREQUENCY	LOM INPUT	REFLECTION COEFFICIEN	
(GHz)	IMPEDANCE	MAG	ANGLE
0.2	96-j64	0.494	-30.6
0.25	86-j57	0.455	-35.1
0.3	77-j51	0.42	-40.2
0.4	69-j41	0.356	-46.6
0.5	62-j33	0.3	-54.1
0.6	58-j28	0.258	-59.1
0.7	55-j24	0.229	-66.6
0.8	52-j21	0.203	-73.1
0.9	50-j19	0.192	-80.6
1.0	48-j18	0.179	-87.5
1.2	44-j16	0.176	-102
1.4	41-j15	0.185	-112
1.6	39-j14	0.196	-119
1.8	38-j14	0.202	-123
2.0	37-j12	0.201	-128
2.5	36-j7.9	0.188	-146
3.0	32-j2.7	0.225	-170
3.5	28+j0.8	0.292	176
4.0	24+j2.0	0.348	172
4.5	23+j3.6	0.373	168
5.0	21+j5.9	0.42	162
5.5	19+j7.5	0.468	159
6.0	16+j8.5	0.518	157

Table 5. LOM Port Input Impedance vs Frequency for EN = Low and P_{LOM} = 10dBm (LOP Terminated with 50 Ω AC to Ground)

FREQUENCY	LOM INPUT	REFLECTION	COEFFICIENT
(GHz)	IMPEDANCE	MAG	ANGLE
0.2	92-j61	0.48	-32.1
0.25	83-j55	0.444	-36.9
0.3	75-j50	0.414	-42
0.4	66-j39	0.345	-49.3
0.5	60-j32	0.293	-57.4
0.6	56-j27	0.251	-63.2
0.7	53-j23	0.225	-71.2
0.8	50-j20	0.199	-78.8
0.9	48-j19	0.191	-86.6
1.0	46-j17	0.18	-93.6
1.2	42-j15	0.181	-108
1.4	40-j14	0.192	-117
1.6	38-j14	0.205	-123
1.8	37-j13	0.211	-127
2.0	36-j12	0.212	-132
2.5	35-j7.5	0.202	-150
3.0	31-j2.2	0.244	-172
3.5	27+j1.3	0.31	175
4.0	24+j2.7	0.363	171
4.5	22+j4.4	0.389	166
5.0	20+j6.8	0.433	160
5.5	18+j8.5	0.479	157
6.0	16+j9.5	0.525	154

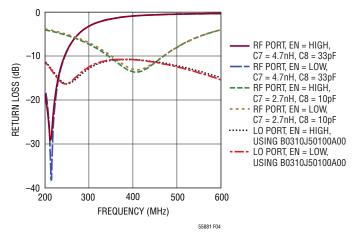


Figure 4. RF and LO Port Return Loss vs Frequency for Low Band Match (See Figure 8)

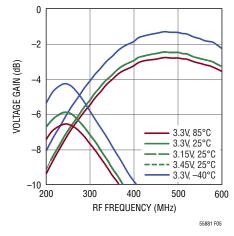


Figure 5. Low Band Voltage Gain vs RF Frequency Using Figure 4 Matching

The third harmonic content of the LO can degrade image rejection severely, it is recommended to keep the 3rd-order harmonic of the LO signal lower than the desirable image rejection minus 6dB. Although the second harmonic content of the LO is less sensitive, it can still be significant. The large-signal noise figure can be improved with higher LO input power. However, if the LO input power is too large to cause the internal LO signal clipping in the phase-shifter section, the image rejection can be degraded rapidly. This clipping point depends on the supply voltage, LO frequency, temperature and single ended vs differential LO drive. At $f_{LO} = 2140 \text{MHz}$, $V_{CC} = 3.3 \text{V}$, $T = 25 ^{\circ}\text{C}$ and single-ended LO drive, this clipping point is at about 16.7dBm. For 3.15V it lowers to 16.1dBm. For differential drive it is about 21.6dBm.

The differential LO port input impedance for EN = High and P_{LO} = 10dBm is given in Table 6.

Table 6: Differential LO Input Impedance vs Frequency for EN = High and P_{L0} = 10dBm

	LO	REFLECTION COEFFICIENT		
FREQUENCY (MHz)	DIFFERENTIAL Input Impedance	MAG	ANGLE	
0.2	134-j48	0.247	-43	
0.25	126-j51	0.247	-50	
0.3	119-j46	0.223	-55	
0.4	109-j45	0.215	-66	
0.5	100-j40	0.194	-79	
0.6	97-j36	0.181	-84	
0.7	94-j36	0.184	-90	
0.8	90-j35	0.186	-96	
0.9	84-j34	0.198	-104	
1.0	83-j33	0.198	-107	
1.2	77-j36	0.237	-111	
1.4	76-j37	0.243	-111	
1.6	73-j38	0.262	-113	
1.8	74-j37	0.254	-113	
2.0	74-j35	0.251	-115	
2.5	78-j28	0.199	-120	
3.0	74-j15	0.173	-145	
3.5	67-j2.9	0.197	-174	
4.0	58+j7.3	0.275	168	
4.5	51+j15	0.338	158	
5.0	42+j18	0.433	156	
5.5	34+j20	0.515	156	
6.0	27+j16	0.596	160	

Table 7: Differential LO Input Impedance vs Frequency for EN = Low and $P_{LO} = 10dBm$

	L0	REFLECTION COEFFICIENT	
FREQUENCY (MHz)	DIFFERENTIAL Input Impedance	MAG	ANGLE
0.2	131-j48	0.243	-45
0.25	125-j52	0.250	- 52
0.3	117-j46	0.221	– 58
0.4	107-j45	0.215	-69
0.5	98-j40	0.197	-81
0.6	95-j36	0.183	-87
0.7	92-j35	0.186	-93
0.8	88-j34	0.188	-99
0.9	83-j33	0.200	-107
1.0	82-j32	0.199	-110
1.2	75-j35	0.237	-114
1.4	76-j35	0.240	-113
1.6	72-j36	0.259	-115
1.8	74-j35	0.248	-115
2.0	73-j33	0.245	-118
2.5	77-j25	0.191	-125
3.0	73-j12	0.172	-152
3.5	66-j0.2	0.206	180
4.0	56+j10	0.293	164
4.5	49+j18	0.362	154
5.0	39+j21	0.459	153
5.5	32+j22	0.538	153
6.0	25+j18	0.619	158

RF Section

After upconversion, the RF outputs of the I and Q mixers are combined. An on-chip balun performs internal differential to single-ended conversion, while transforming the output signal to 50Ω as shown in Figure 1.

Table 8 shows the RF port output impedance vs frequency for EN = High.

Table 8. RF Output Impedance vs Frequency for EN = High

EDEOUENCY .	DE QUEDUT	REFLECTION COEFFICIENT	
FREQUENCY (MHz)	RF OUTPUT Impedance	MAG	ANGLE
0.2	7.8+j11	0.742	154
0.25	8.7+j13	0.723	149
0.3	9.7+j16	0.702	143
0.4	12+j21	0.660	133
0.5	16+j25	0.609	123
0.6	19+j29	0.560	114
0.7	24+j32	0.509	106
0.8	30+j34	0.457	98
0.9	35+j35	0.409	91
1.0	41+j34	0.359	85
1.2	52+j28	0.266	70
1.4	58+j18	0.180	57
1.6	58+j7.1	0.098	39
1.8	55+j0.2	0.042	3.4
1.9	52-j2.7	0.032	-52
2.0	50-j4.3	0.043	-92
2.5	39-j5.9	0.142	-149
3.0	32-j1.9	0.227	-173
3.2	30-j0.2	0.255	-180
3.5	27+j2.2	0.298	172
4.0	23+j4.5	0.365	167
4.5	22+j6.8	0.406	161
5.0	19+j11	0.475	151
5.5	17+j20	0.541	133
6.0	15+j27	0.613	120

The RF port output impedance for EN = Low is given in Table 9.

Table 9. RF Output Impedance vs Frequency for EN = Low

FREQUENCY (MHz)	RF OUTPUT IMPEDANCE	REFLECTION COEFFICIENT	
		MAG	ANGLE
0.2	7.2+j11	0.761	155
0.25	8.0+j13	0.742	149
0.3	9.0+j16	0.720	144
0.4	12+j21	0.675	133
0.5	15+j25	0.622	123
0.6	19+j29	0.571	115
0.7	23+j32	0.518	107
0.8	29+j34	0.464	99
0.9	35+j35	0.414	92
1.0	40+j34	0.363	86
1.2	51+j28	0.266	72
1.4	57+j18	0.175	60
1.6	57+j7.0	0.090	43
1.8	53+j0.4	0.030	7.0
1.9	51-j2.4	0.025	-74
2.0	48-j4.0	0.044	-111
2.5	38-j4.9	0.153	-155
3.0	31-j0.7	0.240	-177
3.2	29+1.0	0.266	-177
3.5	27+j3.6	0.308	169
4.0	24+j5.6	0.365	164
4.5	22+j6.9	0.405	161
5.0	19+j11	0.478	151
5.5	17+j20	0.563	132
6.0	15+j28	0.628	118

Linearity Optimization

The LINOPT pin (Pin 7) can be used to optimize the linearity of the RF circuitry. Figure 6 shows the simplified schematic of the LINOPT pin interface. The nominal DC bias voltage of the LINOPT pin is 2.56V and the typical voltage window to drive the LINOPT pin for optimum linearity is 2V to 3.7V. Since its input impedance for EN = High is about 150 Ω , an external buffer may be required to output a current in the range of –2mA to 8mA. The LINOPT voltage for optimum linearity is a function of LO frequency, temperature, supply voltage, baseband frequency, high side or low side LO injection, process, signal bandwidth and RF output level.

For zero-IF systems the spectral regrowth is typically limited by the OIP2 performance. In that case, optimizing the LINOPT pin voltage may not improve the spectral regrowth. The spectral regrowth for systems with an IF (for example 140MHz) will be set by the OIP3 performance and optimizing LINOPT voltage can improve the spectral regrowth significantly (see Figure 13).

Enable Interface

Figure 7 shows a simplified schematic of the EN pin interface. The voltage necessary to turn on the LTC5588-1 is 2V. To disable (shut down) the chip, the enable voltage must be below 1V. If the EN pin is not connected, the chip is enabled. This EN = High condition is assured by the 100k on-chip pull-up resistor.

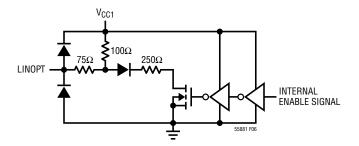


Figure 6. LINOPT Pin Interface

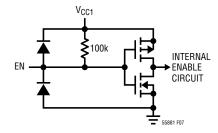


Figure 7. EN Pin Interface

LINEAR

Evaluation Board

Figure 8 shows the evaluation board schematic. A good ground connection is required for the exposed pad. If this is not done properly, the RF performance will degrade. Additionally, the exposed pad provides heat sinking for the part and minimizes the possibility of the chip overheating. Resistors R1 and R2 reduce the charging current in capacitors C1 and C2 (see Figure 8) and will reduce supply ringing during a fast power supply ramp-up with inductive wiring connecting V_{CC} and GND. For EN = High, the

voltages applied directly to the chip can be monitored by measuring at the test points TP1 and TP2. If a power supply is used that ramps up slower than 7V/ μ s and limits the overshoot on the supply below 3.8V, R1 and R2 can be omitted. To facilitate turn-on and turn-off time measurements, the microstrip between J5 and J7 can be used connecting J5 to a pulse generator, J7 to an oscilloscope with 50Ω input impedance, removing R5 and inserting a 0Ω resistor for R3.

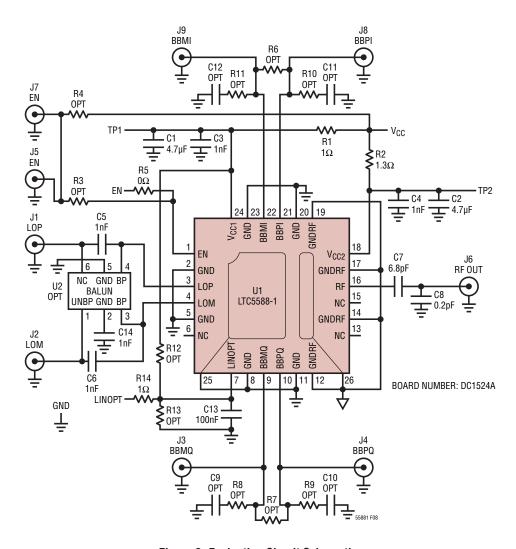


Figure 8. Evaluation Circuit Schematic